19-3134; Rev 2; 4/08



1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

General Description

The MAX9770 combines a mono, filterless, Class D speaker amplifier and stereo DirectDrive® headphone amplifier in a single device. The MAX9770 operates from a single 2.5V to 5.5V supply and includes features that reduce external component count, system cost, board space, and offer improved audio reproduction.

The speaker amplifier makes use of Maxim's Class D architecture, providing Class AB performance with Class D efficiency, conserving board space, and extending battery life. The speaker amplifier delivers 1.2W into an 8Ω load while offering efficiencies above 85%. A spread-spectrum modulation scheme reduces radiated emissions caused by the modulation frequency. Furthermore, the MAX9770 oscillator can be synchronized to an external clock through the SYNC input, avoiding possible problem frequencies inside a system. The speaker amplifier features THD+N as low as 0.025%, high 70dB PSRR, and SNR in excess of 90dB.

The headphone amplifiers feature Maxim's DirectDrive architecture that produces a ground-referenced output from a single supply, eliminating the need for large DC-blocking capacitors. The headphone amplifiers deliver up to 80mW into a 16 Ω load, feature low 0.015% THD+N, high 85dB PSRR, and ±8kV ESD-protected outputs. A headphone sense input detects the presence of a headphone, and automatically configures the amplifiers for either speaker or headphone mode.

The MAX9770 includes internally set, logic-selectable gain, and a comprehensive input multiplexer/mixer, allowing multiple audio sources to be selected and for true mono reproduction of a stereo source in speaker mode. Industry-leading click-and-pop suppression eliminates audible transients during power and shutdown cycles. A low-power shutdown mode decreases supply current consumption to 0.1μ A, further extending battery life.

The MAX9770 is offered in space-saving, thermally efficient 28-pin TQFN (5mm x 5mm x 0.8mm) and 28-pin TSSOP packages. The MAX9770 features thermal-overload and output short-circuit protection, and is specified over the extended -40°C to +85°C temperature range. **Applications**

> Cellular Phones Compact Notebooks PDAs

_ Features

- 1.2W Filterless Class D Amplifiers Pass FCC Class B Radiated EMI Standards with 100mm of Cable
- Spread-Spectrum Mode Offers 5dB EMI Improvement over Conventional Methods
- 80mW DirectDrive Headphone Amplifier Eliminates Bulky DC-Blocking Capacitors
- ♦ High 85dB PSRR at 217Hz
- ♦ 85% Efficiency
- ♦ Low 0.015% THD+N
- Industry-Leading Click-and-Pop Suppression
- Integrated 3-Way Input Mixer/Multiplexer (MAX9770)
- Logic-Adjustable Gain
- Short-Circuit and Thermal Protection
- Available in Space-Saving, Thermally Efficient Packages

Ordering Information

PART	PIN-PACKAGE	SELECTABLE INPUTS
MAX9770ETI+	28 TQFN-EP*	2 stereo, 1 mono
MAX9770EUI	28 TSSOP	2 stereo, 1 mono
•• • • • • •	100 1	1000 . 0500

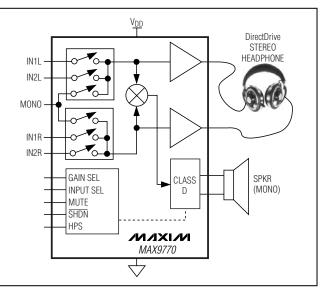
Note: All devices specified over the -40°C to +85°C operating temperature range.

*EP = Exposed pad.

+Denotes a lead-free package.

Pin Configuration appears at end of data sheet.

_Simplified Block Diagram



_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

GND to PGND to CPGND0.3V to +0.3V
V _{DD} to PV _{DD} to CPV _{DD} 0.3V to +0.3V
V _{DD} to GND+6V
PV _{DD} to PGND+6V
CPV _{DD} to CPGND+6V
CPV _{SS} to CPGND6V
SV _{SS} to GND6V
C1N($PV_{SS} - 0.3V$) to (CPGND + 0.3V)
HPOUT_ to GND±3V
All Other Pins to GND $0.3V$ to (V _{DD} + $0.3V$)
Continuous Current Into/Out of:
PV _{DD} , PGND, OUT600mA
PV _{SS}
Duration of HPOUT_ Short Circuit to VDD, PVDD,

GND, PGNDContinuous

Duration of Short Circuit Between	
HPOUTL and HPOUTRContinuous	
Duration of OUT_ Short Circuit to V _{DD} , PV _{DD} , GND, PGND10s	
Duration of Short Circuit Between OUT+ and OUT10s	
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
28-Pin TQFN (derate 20.8mW/°C above +70°C)1667mW	
28-Pin TSSOP (derate 12.8mW°C above +70°C)1026mW	
Junction Temperature+150°C	

40°C to +85°C
65°C to +150°C
+300°C

MIXIM

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = PV_{DD} = CPV_{DD} = 3.3V, GND = PGND = CPGND = 0V, \overline{SHDN} = 3.3V, C1 = C2 = 1\mu F, C_{BIAS} = 0.047\mu F, SYNC = GND, R_L = \infty$, speaker load connected between OUT+ and OUT-, headphone load connected between HPOUT_ and GND, TA = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at TA = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	ТҮР	МАХ	UNITS		
GENERAL		•							<u>.</u>	
Supply Voltage Range	V _{DD}	Inferred fr	om PSI	R test		2.5		5.5	V	
Quiescent Supply Current		No load		Headpho	one mode		5.5	10	mA	
Quiescent Supply Current	IDD	110 10au		Speaker	mode		5.2	7.5	IIIA	
Shutdown Supply Current	ISHDN	SHDN = H	HPS = (GND			0.1	10	μA	
Shutdown to Full Operation	ton						50		ms	
Input Impedance	R _{IN}	(Note 3)		MONO		7	10		kΩ	
input impedance	NIN	(NOLE 3)		INL_, INF	}_	14	20		K52	
Bias Voltage	VBIAS					1.1	1.25	1.4	V	
Feedthrough		From any unselected input to any output, f = 10kHz				70		dB		
SPEAKER AMPLIFIER (GAIN1 =	GAIN2 = VD	_D , HPS = G	ND)							
Output Offset Voltage	VOS						±15	±70	mV	
				$V_{DD} = 2.5V$ to 5.5V, T _A = +25°C				70		
Power-Supply Rejection Ratio	PSRR	(Note 4)	VRIP	$P_{LE} = 200 \text{mV}_{P}$	_{-P} , f = 217Hz		70		dB	
			$V_{RIPPLE} = 200 m V_{P-P}$, f = 1kHz			68		1		
		$V_{RIPPLE} = 200 mV_{P-P}, f = 20 kHz$			50		1			
		f = 1kHz,			$R_L = 8\Omega$		550			
Output Power	Pout	THD+N =	'	$V_{DD} = 3.3V$	$R_L = 4\Omega$		900		mW	
		GAIN1 = GAIN2 =	'	$V_{DD} = 5V$	$R_L = 8\Omega$		1200]	

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = PV_{DD} = CPV_{DD} = 3.3V, GND = PGND = CPGND = 0V, \overline{SHDN} = 3.3V, C1 = C2 = 1\mu F, C_{BIAS} = 0.047\mu F, SYNC = GND, R_L = \infty$, speaker load connected between OUT+ and OUT-, headphone load connected between HPOUT_ and GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL		C	ONDI	TIONS		MIN	ТҮР	МАХ	UNITS
		$R_L = 8\Omega$,	Pout =	300r	mW, f = 1	kHz		0.025		
Total Harmonic Distortion Plus	THD+N	$R_L = 4\Omega$, $P_{OUT} = 300$ mW, f = 1kHz					0.03		%	
Noise	TIDTI	$R_L = 8\Omega,$ f = 1kHz	Pout =	500r	mW,			0.1		,0
Signal-to-Noise Ratio	SNR	$R_L = 8\Omega$,	V _{OUT} =	2V _{RI}	_{MS} , A-we	ghted		85.9		dB
		SYNC = 0	GND				980	1100	1220	
Output Switching Frequency	fS	SYNC = u	unconne	ected			1280	1450	1620	kHz
Output Switching Frequency	15	SYNC = \	/ _{DD}					1220 ±120kHz		- NI IZ
SYNC Frequency Lock Range							800		2000	kHz
Efficiency	η	$P_{O} = 100$	0mW, f	= 1kł	Ηz			85		%
		GAIN1 =	0, GAIN	12 = 0	C			6		
	A	GAIN1 =	0, GAIN	12 = -	1			3		
Gain (MAX9770)	Av	GAIN1 = 1, GAIN2 = 0				9		dB		
		GAIN1 =	1, GAIN	12 = -	1			0		
Gain Accuracy									±5	%
Speaker Path Off-Isolation		$HPS = V_{E}$ $f = 1kHz$	_D , head	dphor	ne amplif	ier active,		102		dB
		Peak voltage, Into shutdown			-76					
Click-and-Pop Level	K _{CP} s	A-weighted, 32	Kon		Out of s	hutdown		-55		dB
		samples per second Into mute			-83					
		(Notes 4,	/		Out of m	nute		-69		
HEADPHONE AMPLIFIER (GAIN Output Offset Voltage	V _{OS}	= 0, пр 5 :	= VDD)				1	±5	±10	mV
Output Onset voltage	VOS			2 51/	1 to 5 51/	TA - 125°C	65	±3 76	±10	IIIV
			$V_{DD} = 2.5V$ to 5.5V, $T_A = +25^{\circ}C$ $V_{RIPPLE} = 200mV_{P-P}$, f = 217Hz		05	70		_		
Power-Supply Rejection Ratio	PSRR	(Note 4)				f = 1 kHz		82		dB
						$r_{\rm r} = 1000$, f = 20kHz	<u> </u>	56		1
				2	_001110P-F	$R_L = 32\Omega$	40	55		
		$T_A = +25^{\circ}$ f = 1kHz,	°C,	Vdd) = 3.3V	$R_{\rm L} = 16\Omega$		40		-
Output Power	Pout	T = TKHZ, THD+N =	1%			$R_L = 32\Omega$		60		mW
		(Note 3)	- 1	Vdd) = 5V	$R_L = 16\Omega$		80		1
		(11010-0)						00		
Total Harmonic Distortion Plus		$R_L = 32\Omega$	POUT	= 50r	nW f = 1	kHz		0.015		

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = PV_{DD} = CPV_{DD} = 3.3V, GND = PGND = CPGND = 0V, \overline{SHDN} = 3.3V, C1 = C2 = 1\mu F, C_{BIAS} = 0.047\mu F, SYNC = GND, R_L = \infty$, speaker load connected between OUT+ and OUT-, headphone load connected between HPOUT_ and GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	COND	ITIONS	MIN	ТҮР	MAX	UNITS	
Signal-to-Noise Ratio	SNR	$R_L = 32\Omega$, $V_{OUT} = 30$ BW = 22Hz to 22kHz		101		dB		
Crosstalk		Between channels, f : V _{IN} = 200mV _{P-P}	= 1kHz,		80		dB	
Headphone Off-Isolation		HPS = GND, speaker f = 1kHz	amplifier active,		96		dB	
		Peak voltage, A-	Into shutdown		-58			
Click-and-Pop Level	KCP	weighted, 32	Out of shutdown		-53		dBV	
Click-and-Fop Level	КСР	samples per second	Into mute		-92		uвv	
		(Notes 4, 5)	Out of mute		-73			
Capacitive-Load Drive	CL				1000		pF	
		GAIN1 = 0, GAIN2 =	0		7			
		GAIN1 = 0, GAIN2 =		4				
Gain	Av	GAIN1 = 1, GAIN2 = 0			-2		dB	
		GAIN1 = 1, GAIN2 =	1		1		1	
Gain Accuracy						±2.5	%	
ESD Protection		HPOUTR, HPOUTL, II	EC Air Discharge		±8		kV	
DIGITAL INPUTS (SHDN, SYNC,	HPS, GAIN_	, SEL_)		•				
Input Voltage High	VIH		2			V		
Input Voltage Low	VIL				0.8	V		
In put Legice to Quirrent (Nists O)		SYNC input			±25	μA		
Input Leakage Current (Note 6)		All other logic inputs		±1				
HPS Input Current		HPS = GND				-10	μA	

Note 1: All devices are 100% production tested at +25°C. All temperature limits are guaranteed by design.

Note 2: Speaker amplifier testing performed with a resistive load in series with an inductor to simulate an actual speaker load. For $R_L = 4\Omega$, $L = 47\mu$ H. For $R_L = 8\Omega$, $L = 68\mu$ H.

Note 3: Guaranteed by design, not production tested.

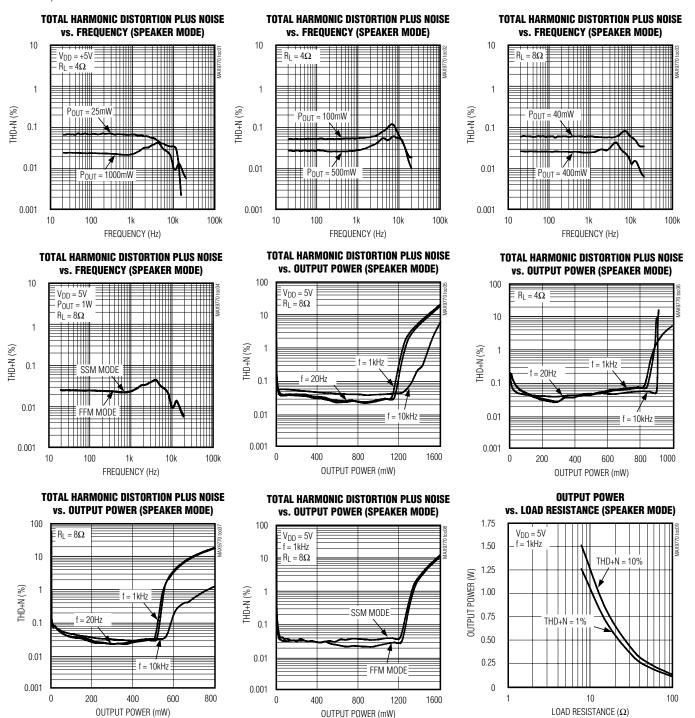
Note 4: Inputs AC-coupled to GND.

Note 5: Speaker mode testing performed with an 8 Ω resistive load in series with a 68 μ H inductive load connected across BTL output. Headphone mode testing performed with a 32 Ω resistive load connected to GND. Mode transitions are controlled by \overline{SHDN} . K_{CP} level is calculated as: 20 x log [(peak voltage during mode transition, no input signal)/(peak voltage under normal operation at rated power level)]. Units are expressed in dB. Measured with V_{DD} = 5V.

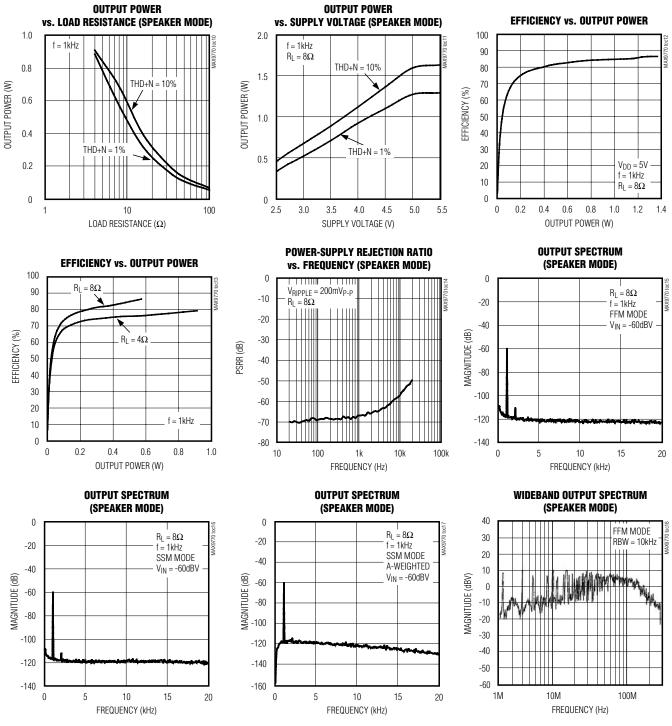
Note 6: SYNC has a 200k Ω resistor to V_{REF} = 1.25V.

Typical Operating Characteristics

(V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)



Typical Operating Characteristics (continued) (V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)

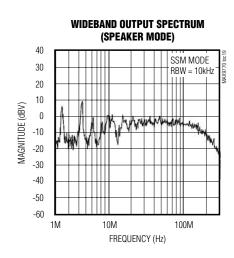


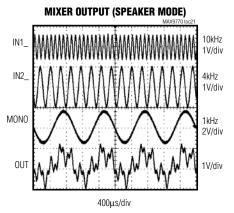
M/IXI/M

MAX9770

Typical Operating Characteristics (continued)

 $(V_{DD} = 3.3V, BW = 22Hz$ to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)





10

1

0.1

0.01

0.001

10

(%) N+DH

 $R_{I} = 16\Omega$

Pour

100

= 10mW

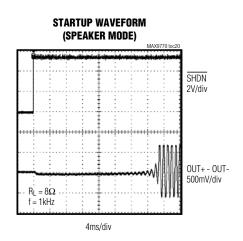
POUT = 35mW

10

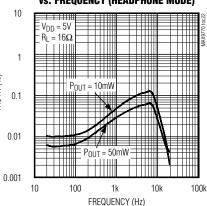
100k

1k

FREQUENCY (Hz)

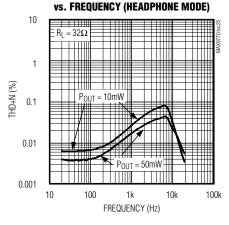


TOTAL HARMONIC DISTORTION PLUS NOISE vs. Frequency (headphone mode)



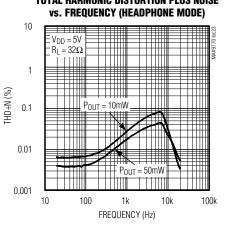
THD+N (%)

TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY (HZ) total harmonic distortion plus noise vs. FREQUENCY (HEADPHONE MODE)

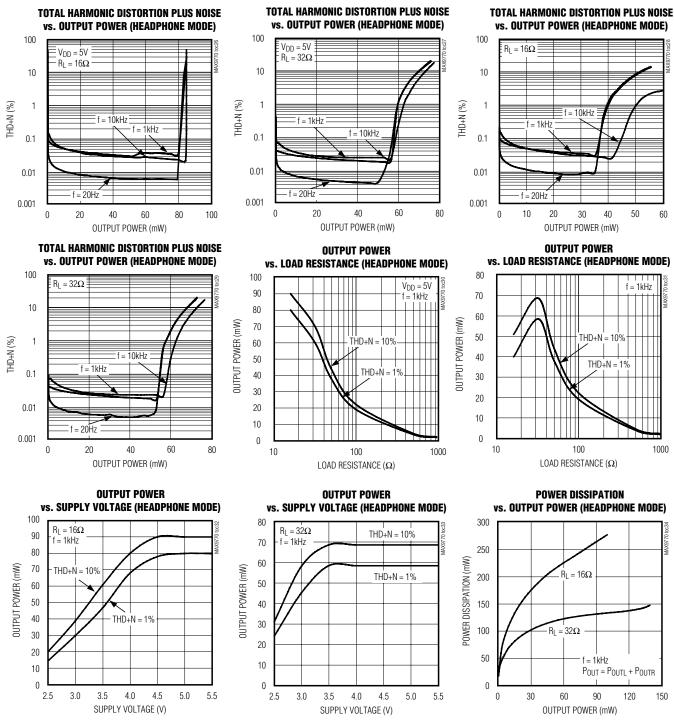


MAX9770

TOTAL HARMONIC DISTORTION PLUS NOISE



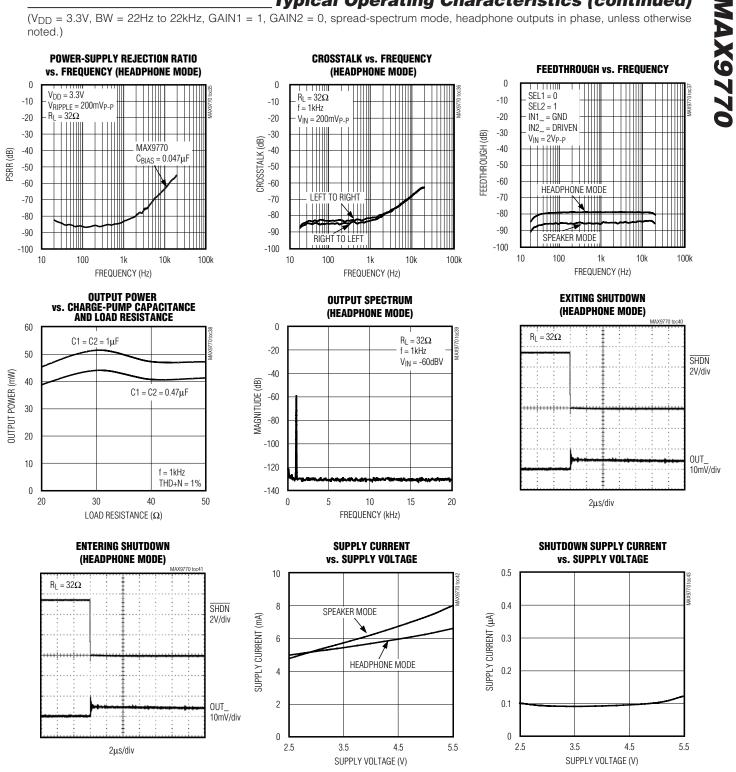
(V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)



M/X/M

Typical Operating Characteristics (continued)

(V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)



M /X / M

Pin Description

PIN							
TQFN-EP	TSSOP	NAME	FUNCTION				
1	4	BIAS	Common-Mode Bias Voltage. Bypass with a 0.047µF capacitor to GND.				
2	5	V _{DD}	Power Supply				
3	6	HPOUTR	Right-Channel Headphone Output				
4	7	HPOUTL	Left-Channel Headphone Output				
5	8	SV _{SS}	Headphone Amplifier Negative Power Supply				
6	9	HPS	Headphone Sense Input				
7	10	CPVDD	Positive Charge-Pump Power Supply				
8	11	CPVSS	Charge-Pump Output. Connect to SV _{SS} .				
9	12	C1N	Charge-Pump Flying Capacitor Negative Terminal				
10	13	C1P	Charge-Pump Flying Capacitor Positive Terminal				
11	14	CPGND	Charge-Pump Ground				
12	15	SEL1	Select Stereo Channel 1 Inputs. Digital input. Drive SEL1 high to select inputs IN1L and IN1R.				
13	16	SEL2	Select Stereo Channel 2 Inputs. Digital input. Drive SEL2 high to select inputs IN2L and IN2R.				
14	17	SELM	Select Mono Channel Input. Digital input. Drive SELM high to select the MONO input.				
15	18	SHDN	Shutdown. Drive $\overline{\text{SHDN}}$ low to disable the device. Connect $\overline{\text{SHDN}}$ to V _{DD} for normal operation.				
16	19	SYNC	Frequency Select and External Clock Input: SYNC = GND: fixed-frequency PWM mode with $f_S = 1100$ kHz. SYNC = Unconnected: fixed-frequency PWM mode with $f_S = 1450$ kHz. SYNC = V_{DD}: spread-spectrum PWM mode with $f_S = 1220$ kHz ±120kHz. SYNC = Clocked: fixed-frequency PWM mode with $f_S =$ external clock frequency.				
17	20	PGND	Speaker Amplifier Power Ground				
18	21	OUT+	Speaker Amplifier Positive Output				
19	22	OUT-	Speaker Amplifier Negative Output				
20	23	PV _{DD}	Speaker Amplifier Power Supply				
21	24	GAIN2	Gain Control Input 2				
22	25	GAIN1	Gain Control Input 1				
23	26	MONO	Mono Channel Input				
24	27	IN2L	Stereo Channel 2, Left Input				
25	28	IN1L	Stereo Channel 1, Left Input				
26	1	GND	Ground				
27	2	IN2R	Stereo Channel 2, Right Input				
28	3	IN1R	Stereo Channel 1, Right Input				
—	—	EP	Exposed Paddle. Can be left unconnected or connected to GND. Connect to ground plane for improved thermal performance.				

M/IXI/M

Detailed Description

The MAX9770 combines a mono 1.2W Class D speaker amplifiers and stereo 80mW DirectDrive headphone amplifiers with integrated headphone sensing and comprehensive click-and-pop suppression. A mixer/multiplexer allows for selection and mixing between two stereo input sources and a single mono source. The MAX9770 features PSRR as high as 85dB, THD as low as 0.015%, industry-leading click-and-pop suppression, and a low-power shutdown mode.

Class D Speaker Amplifier

The MAX9770 Class D amplifier features true filterless, low-EMI, switch-mode architecture that provides Class AB-like performance with Class D efficiency. Comparators monitor the MAX9770 input and compare the input voltage to a sawtooth waveform. The comparators trip when the input magnitude of the sawtooth exceeds the corresponding input voltage. The comparator resets at a fixed time after the rising edge of the

Table 1. Operating Modes

SYNC INPUT	MODE
GND	FFPWM with $f_S = 1100 \text{kHz}$
Unconnected	FFPWM with $f_S = 1450 \text{kHz}$
V _{DD}	SSPWM with $f_S = 1220$ kHz ±120kHz
Clocked	FFPWM with f_S = external clock frequency

second comparator trip point, generating a minimumwidth pulse ton(MIN) at the output of the second comparator (Figure 1). As the input voltage increases or decreases, the duration of the pulse at one output increases (the first comparator trip point) while the other output pulse duration remains at ton(MIN). This causes the net voltage across the speaker (V_{OUT+} -V_{OUT-}) to change.

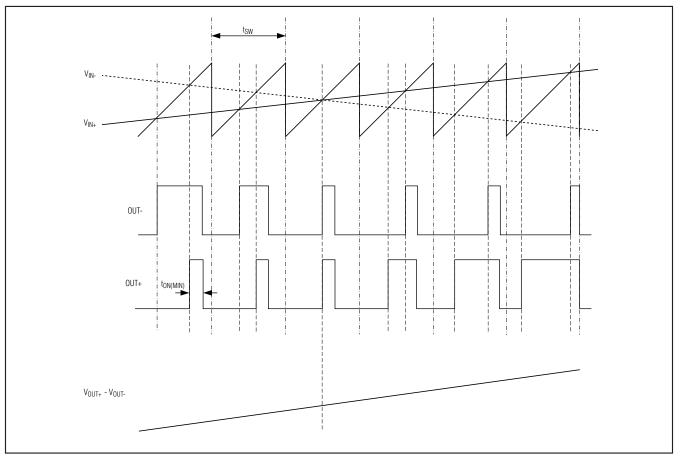


Figure 1. MAX9770 Outputs with an Input Signal Applied

MAX9770

Operating Modes

The switching frequency of the charge pump is 1/2 the switching frequency of the Class D amplifier, regardless of the operating mode. When SYNC is driven externally, the charge pump switches at 1/2 f_{SYNC}. When SYNC = V_{DD} , the charge pump switches with a spread-spectrum pattern.

Fixed-Frequency Modulation (FFM) Mode

The MAX9770 features two FFM modes. The FFM modes are selected by setting SYNC = GND for a 1.1MHz switching frequency, and SYNC = unconnected for a 1.45MHz switching frequency. In FFM mode, the frequency spectrum of the Class D output consists of the fundamental switching frequency and its associated harmonics (see the Wideband Output Spectrum (Speaker Mode) graph in the *Typical Operating Characteristics*). The MAX9770 allows the switching frequency to be changed by +32% should the frequency of one or more harmonics fall in a sensitive band. This can be done during operation and does not affect audio reproduction.

Spread-Spectrum Modulation (SSM) Mode

The MAX9770 features a unique spread-spectrum mode that flattens the wideband spectral components, improving EMI emissions radiated by the speaker and cables by 5dB. Proprietary techniques ensure that the cycle-to-cycle variation of the switching period does not degrade audio reproduction or efficiency (see the Typical Operating Characteristics). Select SSM mode by setting SYNC = V_{OO} . In SSM mode, the switching frequency varies randomly by ±120kHz around the center frequency (1.22MHz). The modulation scheme remains the same, but the period of the sawtooth waveform changes from cycle-to-cycle (Figure 2). Instead of a large amount of spectral energy present at multiples of the switching frequency, the energy is now spread over a bandwidth that increases with frequency. Above a few MHz, the wideband spectrum looks like white noise for EMI purposes (Figure 3).

External Clock Mode

The SYNC input allows the MAX9770 to be synchronized to a system clock (allowing a fully synchronous system), or allocating the spectral components of the switching harmonics to insensitive frequency bands. Applying an external clock of 800kHz to 2MHz to SYNC synchronizes the switching frequency of both the Class D and charge pump. The period of the SYNC clock can be randomized, enabling the MAX9770 to be synchronized to another spread-spectrum Class D amplifier operating in SSM mode.

Filterless Modulation/Common-Mode Idle The MAX9770 uses Maxim's unique modulation scheme that eliminates the LC filter required by traditional Class D amplifiers, improving efficiency, reducing component count, conserving board space and system cost. Conventional Class D amplifiers output a 50% duty cycle square wave when no signal is present. With no filter, the square wave appears across the load as a DC voltage, resulting in finite load current, increasing power con-

sumption. When no signal is present at the device input, the outputs switch as shown in Figure 4. Because the MAX9770 drives the speaker differentially, the two outputs cancel each other, resulting in no net idle mode voltage across the speaker, minimizing power consumption.

Efficiency

The efficiency of a Class D amplifier is attributed to the region of operation of the output stage transistors. In a Class D amplifier, the output transistors act as current-steering switches and consume negligible additional power. Any power loss associated with the Class D output stage is mostly due to the I*R loss of the MOSFET on-resistance, and quiescent current overhead.

The theoretical best efficiency of a linear amplifier is 78%; however, that efficiency is only exhibited at peak output powers. Under normal operating levels (typical music reproduction levels), efficiency falls below 30%, whereas the MAX9770 still exhibits > 80% efficiencies under the same conditions (Figure 5).

DirectDrive

Traditional single-supply headphone drivers have their outputs biased about a nominal DC voltage (typically half the supply) for maximum dynamic range. Large coupling capacitors are needed to block this DC bias from the headphone. Without these capacitors, a significant amount of DC current flows to the headphone, resulting in unnecessary power dissipation and possible damage to both headphone and headphone driver.

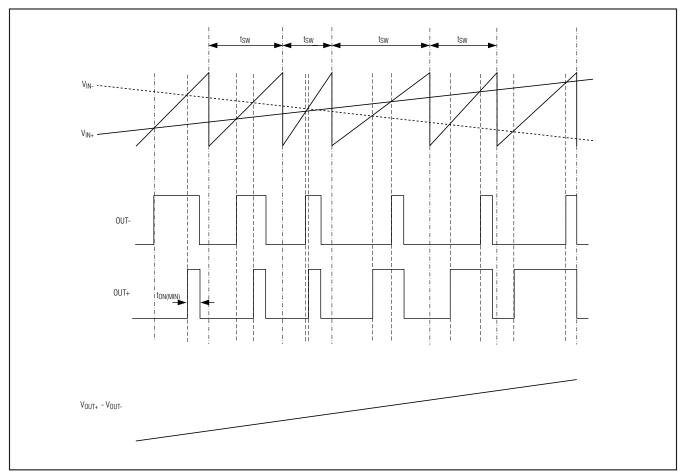


Figure 2. MAX9770 Output with an Input Signal Applied (SSM Mode)

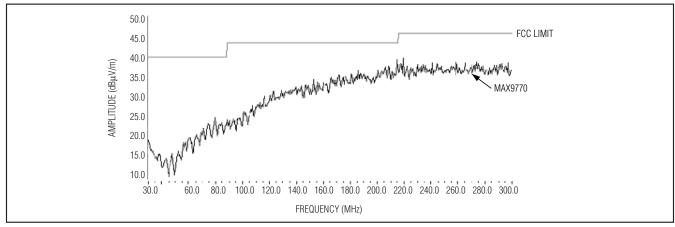


Figure 3. MAX9770 EMI with 75mm of Speaker Cable

MAX9770



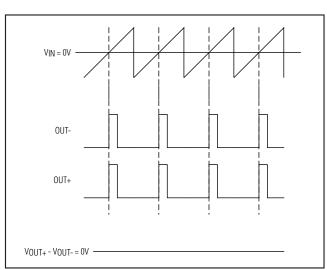


Figure 4. MAX9770 Output with No Signal Applied

Maxim's DirectDrive architecture uses a charge pump to create an internal negative supply voltage. This allows the headphone outputs of the MAX9770 to be biased about GND, almost doubling dynamic range while operating from a single supply. With no DC component, there is no need for the large DC-blocking capacitors. Instead of two large (220µF, typ) tantalum capacitors, the MAX9770 charge pump requires two small ceramic capacitors, which conserves board space, reduces cost, and improves the frequency response of the headphone driver. See the Output Power vs. Charge-Pump Capacitance and Load Resistance graph in the Typical Operating Characteristics for details of the possible capacitor sizes. There is a low DC voltage on the driver outputs due to amplifier offset. However, the offset of the MAX9770 is typically 5mV, which, when combined with a 32Ω load, results in less than 160µA of DC current flow to the headphones.

In addition to the cost and size disadvantages of the DCblocking capacitors required by conventional headphone amplifiers, these capacitors limit the amplifier's low-frequency response and can distort the audio signal.

Previous attempts at eliminating the output-coupling capacitors involved biasing the headphone return (sleeve) to the DC bias voltage of the headphone amplifiers. This method raises some issues:

1) When combining a microphone and headphone on a single connector, the microphone bias scheme typically requires a 0V reference.

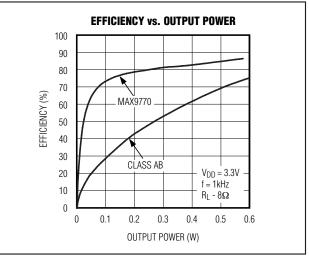


Figure 5. MAX9770 Efficiency vs. Class AB Efficiency

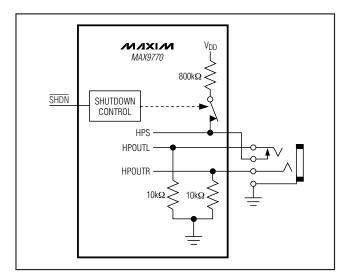


Figure 6. HPS Configuration

- 2) The sleeve is typically grounded to the chassis. Using the midrail biasing approach, the sleeve must be isolated from system ground, complicating product design.
- During an ESD strike, the driver's ESD structures are the only path to system ground. Thus, the driver must be able to withstand the full ESD strike.
- 4) When using the headphone jack as a line out to other equipment, the bias voltage on the sleeve may conflict with the ground potential from other equipment, resulting in possible damage to the drivers.



SEL1	SEL2	SELM	HEADPH	ONE MODE	SPEAKER MODE
SELI	JELZ	SELIN	HPOUTL	HPOUTR	SPEAKER MODE
0	0	0	MUTE	MUTE	MUTE
1	0	0	IN1L	IN1R	(IN1L + IN1R) / 2
0	1	0	IN2L	IN2R	(IN2L + IN2R) / 2
0	0	1	MONO	MONO	MONO
1	1	0	(IN1L + IN2L) / 2	(IN1R + IN2R)/2	(IN1L + IN1R + IN2L + IN2R) / 4
1	0	1	(IN1L + MONO) /2	(IN1R + MONO) / 2	(IN1L + IN1R + MONO x 2) / 4
0	1	1	(IN2L + MONO) / 2	(IN2R + MONO) / 2	(IN2L + IN2R + MONO x 2) / 4
1	1	1	(IN1L + IN2L + MONO) / 3	(IN1R + IN2R + MONO)/3	(IN1L + IN1R + IN2L + IN2R + MONO × 2)/6

Table 2. MAX9770 Multiplexer/Mixer Settings

Charge Pump

The MAX9770 features a low-noise charge pump. The switching frequency of the charge pump is 1/2 the switching frequency of the Class D amplifier, regardless of the operating mode. When SYNC is driven externally, the charge pump switches at 1/2 fsync. When SYNC = VDD, the charge pump switches with a spread-spectrum pattern. The nominal switching frequency is well beyond the audio range, and thus does not interfere with the audio signals, resulting in an SNR of 101dB. The switch drivers feature a controlled switching speed that minimizes noise generated by turn-on and turn-off transients. By limiting the switching speed of the charge pump, the di/dt noise caused by the parasitic bond wire and trace inductance is minimized. Although not typically required, additional high-frequency noise attenuation can be achieved by increasing the size of C2 (see the Block Diagram). The charge pump is active in both speaker and headphone modes.

Input Multiplexer/Mixer

The MAX9770 features an input multiplexer/mixer that allows multiple audio sources to be selected/mixed. Driving a SEL_ input high selects the input channel (see Table 2), and the audio signal is output to the active amplifier. When a stereo path is selected in speaker mode, the left and right inputs are attenuated by 6dB and mixed together, resulting in a true mono reproduction of a stereo signal. When more than one signal path is selected, the sources are attenuated before mixing to preserve overall amplitude. For example, selecting two sources in headphone mode results in 6dB attenuation of the inputs, while selecting three sources in headphone mode results in 9.5dB attenuation of the inputs. Table 2 shows how the input signals are attenuated and mixed for each possible input selection combination.

Headphone Sense Input (HPS)

The headphone sense input (HPS) monitors the headphone jack, and automatically configures the device based upon the voltage applied at HPS. A voltage of less than 0.8V sets the device to speaker mode. A voltage of greater than 2V disables the bridge amplifiers and enables the headphone amplifiers.

For automatic headphone detection, connect HPS to the control pin of a 3-wire headphone jack as shown in Figure 6. With no headphone present, the output impedance of the headphone amplifier pulls HPS to less than 0.8V. When a headphone plug is inserted into the jack, the control pin is disconnected from the tip contact and HPS is pulled to V_{DD} through the internal 800k Ω pullup. When driving HPS from an external logic source, ground HPS when the MAX9770 is shut down. Place a 10k Ω resistor in series with HPS and the headphone jack to ensure ±8kV ESD protection.

BIAS

The MAX9770 features internally generated, power-supply independent, common-mode bias voltages referenced to GND. BIAS provides both click-and-pop suppression and sets the DC bias level for the amplifiers. Choose the value of the bypass capacitor as described in the *BIAS Capacitor* section. No external load should be applied to BIAS. Any load lowers the BIAS voltage, affecting the overall performance of the device.

Gain Selection

The MAX9770 features logic-selectable, internally set gains. GAIN1 and GAIN2 set the gain of the MAX9770 speaker and headphone amplifiers as shown in Table 3.

The MAX9770 can be configured to automatically switch between two gain settings depending on whether the device is in speaker or headphone mode. By driving one or both gain inputs with HPS, the gain of

MAX9770

Table 3. Gain Selection

GAIN1	GAIN2	MAX9770 SPEAKER GAIN (dB)	HEADPHONE GAIN (dB)
0	0	6	7
0	1	3	4
1	0	9	-2
1	1	0	1

Table 4. Gain Settings with HPSConnection

GAIN1	GAIN2	MAX9770 SPEAKER MODE GAIN (HPS = 0) (dB)	HEADPHONE MODE GAIN (HPS = 1) (dB)
HPS	0	6	-2
HPS	1	3	1
0	HPS	6	4
1	HPS	9	1
HPS	HPS	6	1
0	0	6	7
0	1	3	4
1	0	9	-2
1	1	0	1

the device changes when a headphone is inserted or removed. For example, the block diagram shows HPS connected to GAIN2, while GAIN1 is connected to V_{DD}. In this configuration, the gain in speaker mode is 9dB, while the gain in headphone mode is 1dB. The gain settings with the HPS connection are shown in Table 4.

Shutdown

The MAX9770 features a 0.1 μ A, low-power shutdown mode that reduces quiescent current consumption and extends battery life. Drive SHDN low to disable the drive amplifiers, bias circuitry, and charge pump. Bias is driven to GND and the headphone amplifier output impedance is 10k Ω in shutdown. Connect SHDN to V_{DD} for normal operation.

Click-and-Pop Suppression

Speaker Amplifier

The MAX9770 speaker amplifier features comprehensive click-and-pop suppression that eliminates audible transients on startup and shutdown. While in shutdown, the H-bridge is in a high-impedance state. During startup or power-up, the input amplifiers are muted and an internal loop sets the modulator bias voltages to the correct levels, preventing clicks and pops when the H-bridge is subsequently enabled. A soft-start function unmutes the input amplifiers 30ms after startup.

Headphone Amplifier

In conventional single-supply headphone drivers, the output-coupling capacitor is a major contributor of audible clicks and pops. Upon startup, the driver charges the coupling capacitor to its bias voltage, typically half the supply. Likewise, during shutdown, the capacitor is discharged to GND. This results in a DC shift across the capacitor, which in turn, appears as an audible transient at the speaker. Since the MAX9770 headphone amplifier does not require output-coupling capacitors, this does not arise.

Additionally, the MAX9770 features extensive click-andpop suppression that eliminates any audible transient sources internal to the device. The Exiting Shutdown (Headphone Mode) and Entering Shutdown (Headphone Mode) graphs in the *Typical Operating Characteristics* shows that there are minimal spectral components in the audible range at the output upon startup or shutdown.

In most applications, the output of the preamplifier driving the MAX9770 has a DC bias of typically half the supply. During startup, the input-coupling capacitor is charged to the preamplifier's DC bias voltage through the R_F of the MAX9770, resulting in a DC shift across the capacitor and an audible click-and-pop. An internal delay of 50ms eliminates the click-and-pop caused by the input filter.

Applications Information

Filterless Operation

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's output. The filters add cost, increase the solution size of the amplifier, and can decrease efficiency. The traditional PWM scheme uses large differential output swings (2 x V_{DD} peak-to-peak) at idle and causes large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering efficiency.

The MAX9770 does not require an output filter. The device relies on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, and more efficient solution.

Because the frequency of the MAX9770 output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency is minimal.



Although this movement is small, a speaker not designed to handle the additional power may be damaged. For optimum results, use a speaker with a series inductance >10 μ H. Typical small 8 Ω speakers exhibit series inductances in the range of 20 μ H to 100 μ H.

Output Offset

Unlike Class AB amplifiers, the output offset voltage of a Class D amplifier does not noticeably increase quiescent current draw when a load is applied. This is due to the power conversion of the Class D amplifier. For example, a 15mV DC offset across an 8 Ω load results in 1.9mA extra current consumption in a Class AB device. In the Class D case, a 15mV offset into 8Ω equates to an additional power drain of 28 μ W. Due to the high efficiency of the Class D amplifier, this represents an additional quiescent current draw of 28 μ W/(V_{DD} / 100 \times η), which is on the order of a few microamps.

Power Supplies The MAX9770 has different supplies for each portion of the device, allowing for the optimum combination of headroom and power dissipation and noise immunity. The speaker amplifier is powered from PV_{DD}. PV_{DD} ranges from 2.5V to 5.5V. The headphone amplifiers are powered from V_{DD} and SV_{SS}. V_{DD} is the positive supply of the headphone amplifiers and ranges from 2.5V to 5.5V. SV_{SS} is the negative supply of the headphone amplifiers. Connect SV_{SS} to CPV_{SS}. The charge pump is powered by CPV_{DD}. CPV_{DD} ranges from 2.5V to 5.5V and should be the same potential as V_{DD}. The charge pump inverts the voltage at CPV_{DD}, and the resulting voltage appears at CPV_{SS}. The remainder of the device is powered by V_{DD}.

Component Selection

Input Filter

The input capacitor (C_{IN}), in conjunction with the amplifier input resistance (R_{IN}), forms a highpass filter that removes the DC bias from an incoming signal (see the *Block Diagram*). The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN}C_{IN}}$$

 $R_{\rm IN}$ is the amplifier's internal input resistance value given in the *Electrical Characteristics*. Be aware that the MONO input has a lower input impedance than the other inputs. Choose $C_{\rm IN}$ such that f_{-3dB} is below the lowest frequency of interest. Setting f_{-3dB} too high



affects the amplifier's low-frequency response. Setting f-3dB too low can affect the click-and-pop performance. Use capacitors with low-voltage coefficient dielectrics, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies.

Output Filter

The MAX9770 speaker amplifier does not require an output filter for normal operation and audio reproduction. The device passes FCC Class B radiated emissions standards with 100mm of unshielded speaker cables. However, output filtering can be used if a design is failing radiated emissions due to board layout or cable length, or if the circuit is near EMI-sensitive devices. Use a common-mode choke connected in series with the speaker outputs if board space is limited and emissions are a concern. Use of an LC filter is necessary if excessive speaker cable is used.

BIAS Capacitor

BIAS is the output of the internally generated DC bias voltage. The BIAS bypass capacitor, C_{BIAS} improves PSRR and THD+N by reducing power supply and other noise sources at the common-mode bias node, and also generates the clickless/popless, startup/shutdown DC bias waveforms for the speaker amplifiers. Bypass BIAS with a 0.047µF capacitor to GND.

Table 5. Suggested Capacitor Manufacturers

SUPPLIER	PHONE	FAX	WEBSITE
Taiyo Yuden	800-348-2496	847-925-0899	www.t-yuden.com
TDK	807-803-6100	847-390-4405	www.component.tdk.com

Charge-Pump Capacitor Selection

Use capacitors with an ESR less than $100m\Omega$ for optimum performance. Low-ESR ceramic capacitors minimize the output resistance of the charge pump. Most surface-mount ceramic capacitors satisfy the ESR requirement. For best performance over the extended temperature range, select capacitors with an X7R dielectric. Table 5 lists suggested manufacturers.

Flying Capacitor (C1)

The value of the flying capacitor (C1) affects the load regulation and output resistance of the charge pump. A C1 value that is too small degrades the device's ability to provide sufficient current drive, which leads to a loss of output voltage. Increasing the value of C1 may improve load regulation and reduces the charge-pump output resistance to an extent. Above 1μ F, the on-resistance of the switches and the ESR of C1 and C2 dominate.

Output Capacitor (C2)

The output capacitor value and ESR directly affect the ripple at CPV_{SS}. Increasing the value of C2 reduces output ripple. Likewise, decreasing the ESR of C2 reduces both ripple and output resistance. Lower capacitance values can be used in systems with low maximum output power levels. See the Output Power vs. Charge-Pump Capacitance and Load Resistance graph in the *Typical Operating Characteristics*.

CPV_{DD} Bypass Capacitor

The CPV_{DD} bypass capacitor (C3) lowers the output impedance of the power supply and reduces the impact of the MAX9770's charge-pump switching transients. Bypass CPV_{DD} with C3, the same value as C1, and place it physically close to the CPV_{DD} and PGND (refer to the MAX9770 EV kit for a suggested layout).

Layout and Grounding

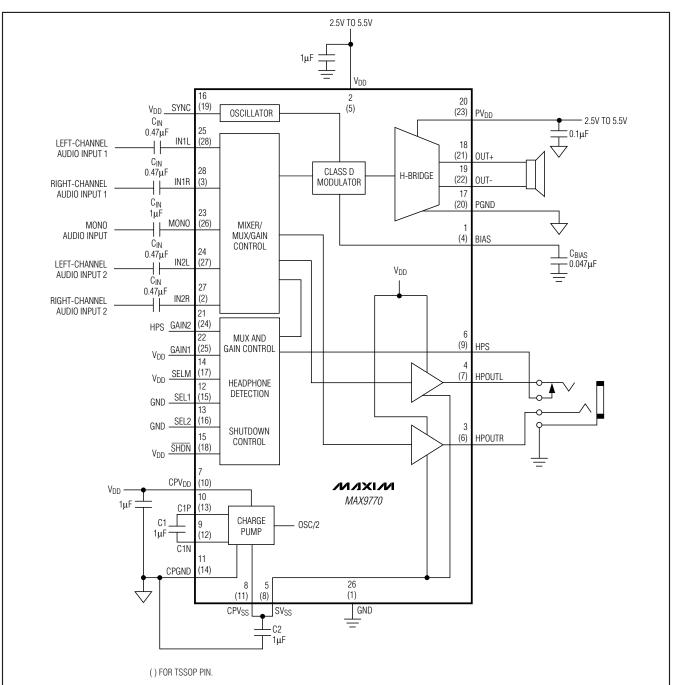
Proper layout and grounding are essential for optimum performance. Use large traces for the power-supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance, as well as route the head away from the device. Good grounding improves audio performance, minimizes crosstalk between channels, and prevents any switching noise from coupling into the audio signal. Connect CPGND, PGND, and GND together at a single point on the PC board. Route CPGND and all traces that carry switching transients away from GND, PGND, and the traces and components in the audio signal path.

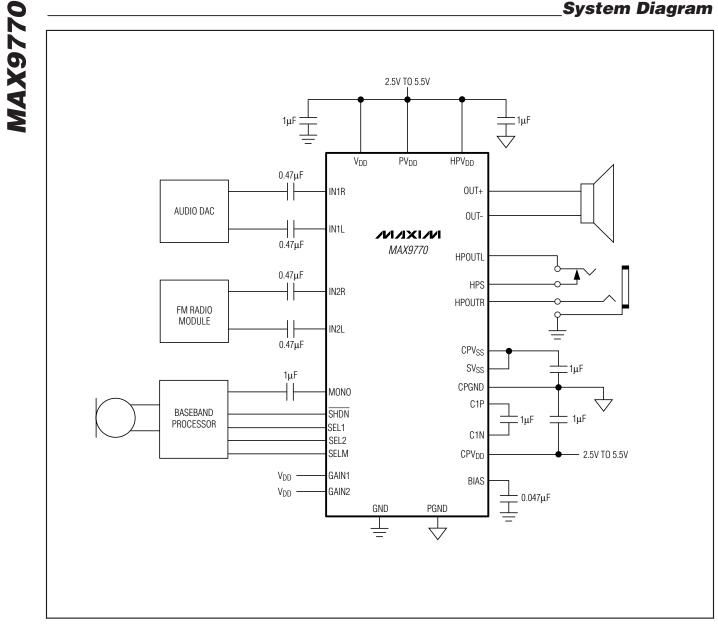
Connect all components associated with the charge pump (C2 and C3) to the CPGND plane. Connect SV_{SS} and CPV_{SS} together at the device. Place the charge-pump capacitors (C1, C2, and C3) as close to the device as possible. Bypass V_{DD} and PV_{DD} with a 1 μ F capacitor to GND. Place the bypass capacitors as close to the device as possible.

Use large, low-resistance output traces. As load impedance decreases, the current drawn from the device outputs increase. At higher current, the resistance of the output traces decrease the power delivered to the load. Large output, supply, and GND traces also improve the power dissipation of the device.

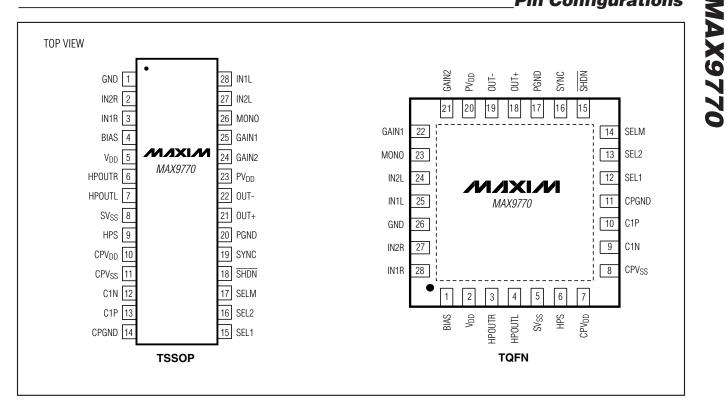
The MAX9770 thin QFN package features an exposed thermal pad on its underside. This pad lowers the package's thermal resistance by providing a direct heat conduction path. Due to the high efficiency of the MAX9770's Class D amplifier, additional heatsinking is not required. If additional heatsinking is required, connect the exposed paddle to GND. See the MAX9770 EV kit data sheet for suggested component values and layout guidelines.

_Block Diagram





System Diagram



Pin Configurations

Chip Information

TRANSISTOR COUNT: 7020 **PROCESS: BICMOS**

Package Information

For the latest package outline information, go to www.maxim-ic.com/packages

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
28 TQFN-EP	T2855N-1	<u>21-0140</u>
28 TSSOP	U28-1	<u>21-0066</u>

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	4/08	Removing MAX9772 from data sheet	1–21

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600

22

MAX9770

© 2008 Maxim Integrated Products

is a registered trademark of Maxim Integrated Products, Inc.